

BTA25-600CW3G, BTA25-800CW3G



Description

Designed primarily for half-wave ac control applications, such as motor controls, heating controls and power supply crowbar circuits.

> • Industry Standard TO-220AB Package

• High Commutating dl/ dt - 14 A/ms minimum at

• Internally Isolated (2500

Devices and are RoHS

• These are Pb-Free

125°C

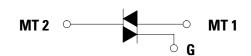
V_{RMS})

Compliant

Features

- Blocking Voltage to 800 V
- On-State Current Rating of 25 A RMS at 25°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dV/ dt – 500 V/µs minimum at 125°C
- Minimizes Snubber Networks for Protection

Functional Diagram



Additional Information





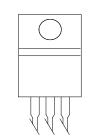
PO

Samples

Pin Out



Style 4



Maximum Ratings (T = 25°C unless otherwise noted)

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Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1)BTA25-600CW3G(Gate Open, Sine Wave 50 to 60 Hz, $T_j = -40^{\circ}$ to 125°C)BTA25-800CW3G	V _{drm} , V _{rrm}	600 800	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, $T_c = 95^{\circ}$ C)	I _{T (RMS)}	25	A
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T _c = 25°C)	I _{TSM}	250	А
Circuit Fusing Consideration (t = 8.3 ms)	l²t	260	A ² sec
Non–Repetitive Surge Peak Off–State Voltage ($T_J = 25^{\circ}C$, t = 8.3 ms)	V _{DSM} /V _{RSM}	V _{DSM} /V _{RSM} +100	V
Peak Gate Current (T_ = 110°C, t \leq 20µs)	I _{GM}	4.0	W
Peak Gate Power (Pulse Width \leq 20 µs, T _c = 80°C)	P _{G(AV)}	20	W
Average Gate Power ($T_{J} = 110^{\circ}$ C)	P _{G(AV)}	1.0	W
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +125	°C
RMS Isolation Voltage (t = 300 ms, R.H. \leq 30%, T _A = 25°C)	V _{iso}	2500	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied.
Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.
V_{DBM} and V_{RBM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics						
Rating		Symbol	Value	Unit		
	Junction-to-Case (AC) Junction-to-Ambient	R _{ejc} R _{eja}	2.13 60	°C/W		
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds		TL	260	°C		

Electrical Characteristics \cdot **OFF** (T₁ = 25°C unless otherwise noted ; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Мах	Unit
Peak Repetitive Blocking Current	T _ = 25°C	I _{DRM} ,	-	-	0.005	m ^
$(V_{D} = V_{DRM} = V_{RRM}; \text{ Gate Open})$	$T_J = 110^{\circ}C$	I	-	-	2.0	mA

Electrical Characteristics - **ON** ($T_1 = 25^{\circ}$ C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Forward On-State Voltage (Note 2) ($I_{TM} = \pm 22.5 \text{ A Peak}$)		V _{TM}	-	-	1.55	V
	MT2(+), G(+)		2.0	-	35	
Gate Trigger Current (Continuous dc) ($V_D = 12 V$, $R_L = 30 \Omega$)	MT2(+), G(-)	I _{gt}	2.0	_	35	mA
	MT2(-), G(-)		2.0	-	35	
Holding Current ($V_p = 12 \text{ V}$, Gate Open, Initiating Current = ±500 mA)		IH	-	-	50	mA
	MT2(+), G(+)		-	-	75	
Latching Current ($V_p = 12 \text{ V}, I_g = 12 \text{ mA}$)	MT2(+), G(-)	IL	_	-	75	mA
	MT2(-), G(-)		-	-	75	
	MT2(+), G(+)		0.5	-	1.3	
Gate Trigger Voltage ($V_D = 12 \text{ V}, \text{ R}_L = 30 \Omega$)	MT2(+), G(-)	V _{gt}	0.5	-	1.3	V
	MT2(-), G(-)		0.5	_	1.3	
	MT2(+), G(+)		0.2	-	-	
Gate Non-Trigger Voltage (T _j = 110°C)	MT2(+), G(-)	V _{gD}	0.2	_	-	V
	MT2(-), G(-)		0.2	-	-	

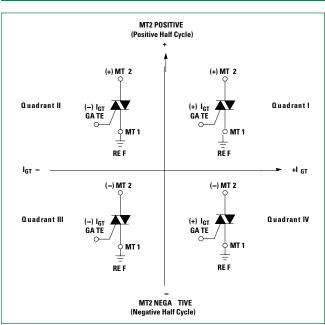
2. Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.



Dynamic Characteristics						
Characteristic	Symbol	Min	Тур	Мах	Unit	
Rate of Change of Commutating Current, See Figure 10. (Gate Open, $T_J = 110^{\circ}$ C, No Snubber)	(dl/dt)c	2.0	-	-	A/ms	
Critical Rate of Rise of On–State Current ($T_J = 110^{\circ}$ C, f = 120 Hz, $I_g = 20$ mA, tr ≤100 ns)	dl/dt	-	_	50	A/µs	
Critical Rate of Rise of Off-State Voltage ($V_{D} = 0.66 \times V_{DRM}$, Exponential Waveform, Gate Open, $T_{J} = 110^{\circ}$ C)	dV/dt	250	-	_	V/µs	

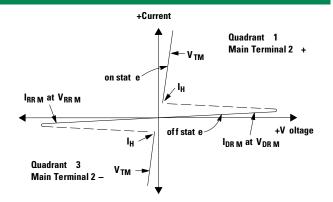
Voltage Current Characteristic of SCR

Symbol	Parameter
V _{drm}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current



Quadrant Definitions for a Triac

All polarities are referenced to MT1 Witn in-phase signals (using standard AC lines) quadrants I and III are used.





Thyristors 25A Alternistor Triac

Figure 1. RMS Current Derating

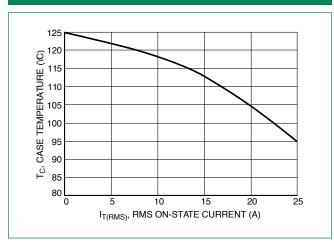


Figure 3. On–State Characteristics

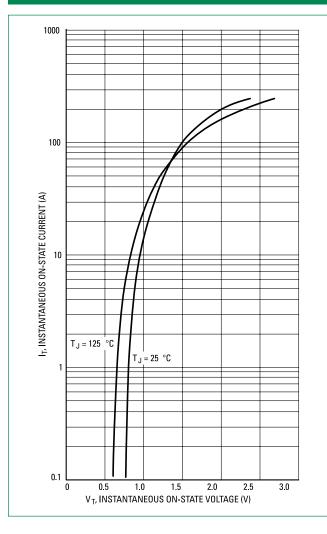


Figure 2. On-State Power Dissipation

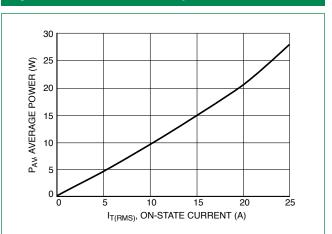


Figure 4. Thermal Response

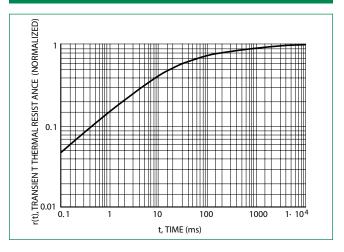
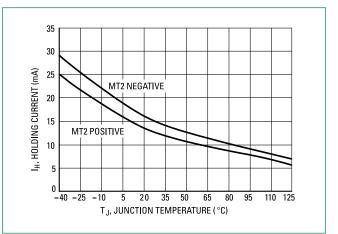


Figure 5. Hold Current Variation





Thyristors 25A Alternistor Triac

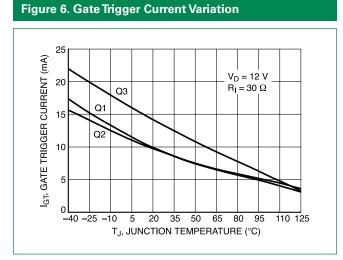


Figure 8. Critical Rate of Rise of Off-State Voltage (Exponential Waveform)

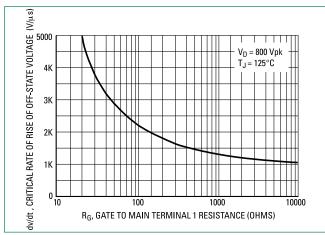


Figure 7. Gate Trigger Voltage Variation

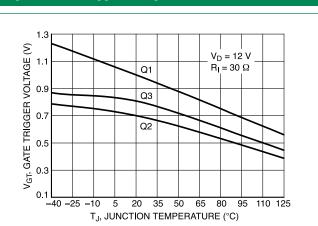


Figure 9. Latching Current Variation

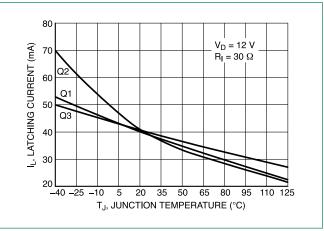
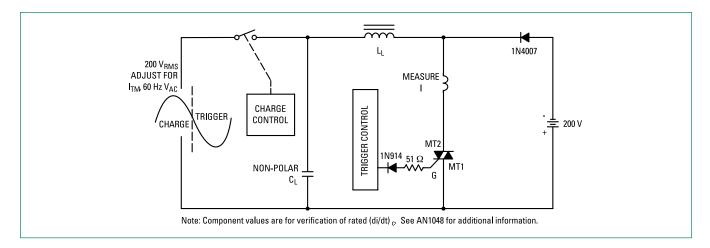


Figure 10. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)



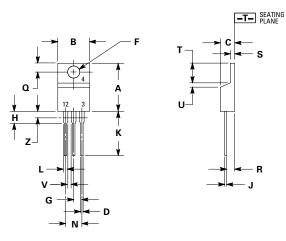


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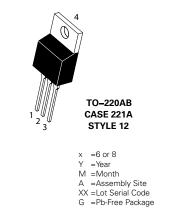
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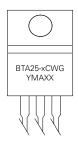
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Dimensions



Part Marking System





Dim	Inches		Millin	neters
Dim	Min	Мах	Min	Max
Α	0.590	0.620	14.99	15.75
В	0.380	0.420	9.65	10.67
С	0.178	0.188	4.52	4.78
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.41	2.67
Н	0.110	0.130	2.79	3.30
J	0.018	0.024	0.46	0.61
К	0.540	0.575	13.72	14.61
L	0.060	0.075	1.52	1.91
N	0.195	0.205	4.95	5.21
٥	0.105	0.115	2.67	2.92
R	0.085	0.095	2.16	2.41
S	0.045	0.060	1.14	1.52
т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
v	0.045		1.15	
Z		0.080		2.04

Pin Assignment			
1	Main Terminal 1		
2	Main Terminal 2		
3	Gate		
4	No Connection		

Ordering	Information
Ordening	mormation

Device	Package	Shipping
BTA25-600SW3G	TO-220AB (Pb-Free)	500 Units / Rail
BTA25-800SW3G	TO-220AB (Pb-Free)	500 Units / Rail

 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

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